



**256K x 36, 512K x 18**  
**3.3V Synchronous ZBT™ SRAMs**  
**3.3V I/O, Burst Counter**  
**Flow-Through Outputs**

**IDT71V65703**  
**IDT71V65903**

## Features

- ◆ 256K x 36, 512K x 18 memory configurations
- ◆ Supports high performance system speed - 100 MHz (7.5 ns Clock-to-Data Access)
- ◆ ZBT™ Feature - No dead cycles between write and read cycles
- ◆ Internally synchronized output buffer enable eliminates the need to control  $\overline{OE}$
- ◆ Single R/W (READ/WRITE) control pin
- ◆ 4-word burst capability (Interleaved or linear)
- ◆ Individual byte write ( $\overline{BW1}$  -  $\overline{BW4}$ ) control (May tie active)
- ◆ Three chip enables for simple depth expansion
- ◆ 3.3V power supply ( $\pm 5\%$ )
- ◆ 3.3V ( $\pm 5\%$ ) I/O Supply ( $V_{DDQ}$ )
- ◆ Power down controlled by ZZ input
- ◆ Packaged in a JEDEC standard 100-pin plastic thin quad flatpack (TQFP), 119 ball grid array (BGA) and 165 fine pitch ball grid array (fBGA)
- ◆ Green parts available, see ordering information

## Description

The IDT71V65703/5903 are 3.3V high-speed 9,437,184-bit (9 Megabit) synchronous SRAMs organized as 256K x 36 / 512K x 18. They are designed to eliminate dead bus cycles when turning the bus around between reads and writes, or writes and reads. Thus they have been given the name ZBT™, or Zero Bus Turnaround.

Address and control signals are applied to the SRAM during one clock cycle, and on the next clock cycle the associated data cycle occurs, be it read or write.

The IDT71V65703/5903 contain address, data-in and control signal registers. The outputs are flow-through (no output data register). Output enable is the only asynchronous signal and can be used to disable the outputs at any given time.

A Clock Enable ( $\overline{CEN}$ ) pin allows operation of the IDT71V65703/5903 to be suspended as long as necessary. All synchronous inputs are ignored when  $\overline{CEN}$  is high and the internal device registers will hold their previous values.

There are three chip enable pins ( $\overline{CE1}$ ,  $\overline{CE2}$ ,  $\overline{CE3}$ ) that allow the user to deselect the device when desired. If any one of these three is not asserted when  $\overline{ADV/LD}$  is low, no new memory operation can be initiated. However, any pending data transfers (reads or writes) will be completed. The data bus will tri-state one cycle after the chip is deselected or a write is initiated.

The IDT71V65703/5903 have an on-chip burst counter. In the burst mode, the IDT71V65703/5903 can provide four cycles of data for a single address presented to the SRAM. The order of the burst sequence is defined by the  $\overline{LBO}$  input pin. The  $\overline{LBO}$  pin selects between linear and interleaved burst sequence. The  $\overline{ADV/LD}$  signal is used to load a new external address ( $\overline{ADV/LD} = \text{LOW}$ ) or increment the internal burst counter ( $\overline{ADV/LD} = \text{HIGH}$ ).

The IDT71V65703/5903 SRAMs utilize a high-performance CMOS process and are packaged in a JEDEC Standard 14mm x 20mm 100-pin plastic thin quad flatpack (TQFP), 119 ball grid array (BGA) and a 165 fine pitch ball grid array (fBGA).

## Pin Description Summary

|                                                                           |                                        |        |              |
|---------------------------------------------------------------------------|----------------------------------------|--------|--------------|
| A0-A18                                                                    | Address Inputs                         | Input  | Synchronous  |
| $\overline{CE1}$ , $\overline{CE2}$ , $\overline{CE3}$                    | Chip Enables                           | Input  | Synchronous  |
| $\overline{OE}$                                                           | Output Enable                          | Input  | Asynchronous |
| R/W                                                                       | Read/Write Signal                      | Input  | Synchronous  |
| $\overline{CEN}$                                                          | Clock Enable                           | Input  | Synchronous  |
| $\overline{BW1}$ , $\overline{BW2}$ , $\overline{BW3}$ , $\overline{BW4}$ | Individual Byte Write Selects          | Input  | Synchronous  |
| CLK                                                                       | Clock                                  | Input  | NA           |
| $\overline{ADV/LD}$                                                       | Advance Burst Address/Load New Address | Input  | Synchronous  |
| $\overline{LBO}$                                                          | Linear/Interleaved Burst Order         | Input  | Static       |
| ZZ                                                                        | Sleep Mode                             | Input  | Asynchronous |
| I/O0-I/O31, I/OP1-I/OP4                                                   | Data Input/Output                      | I/O    | Synchronous  |
| VDD, VDDQ                                                                 | Core Power, I/O Power                  | Supply | Static       |
| VSS                                                                       | Ground                                 | Supply | Static       |

5298 tbl 01

## Pin Definitions<sup>(1)</sup>

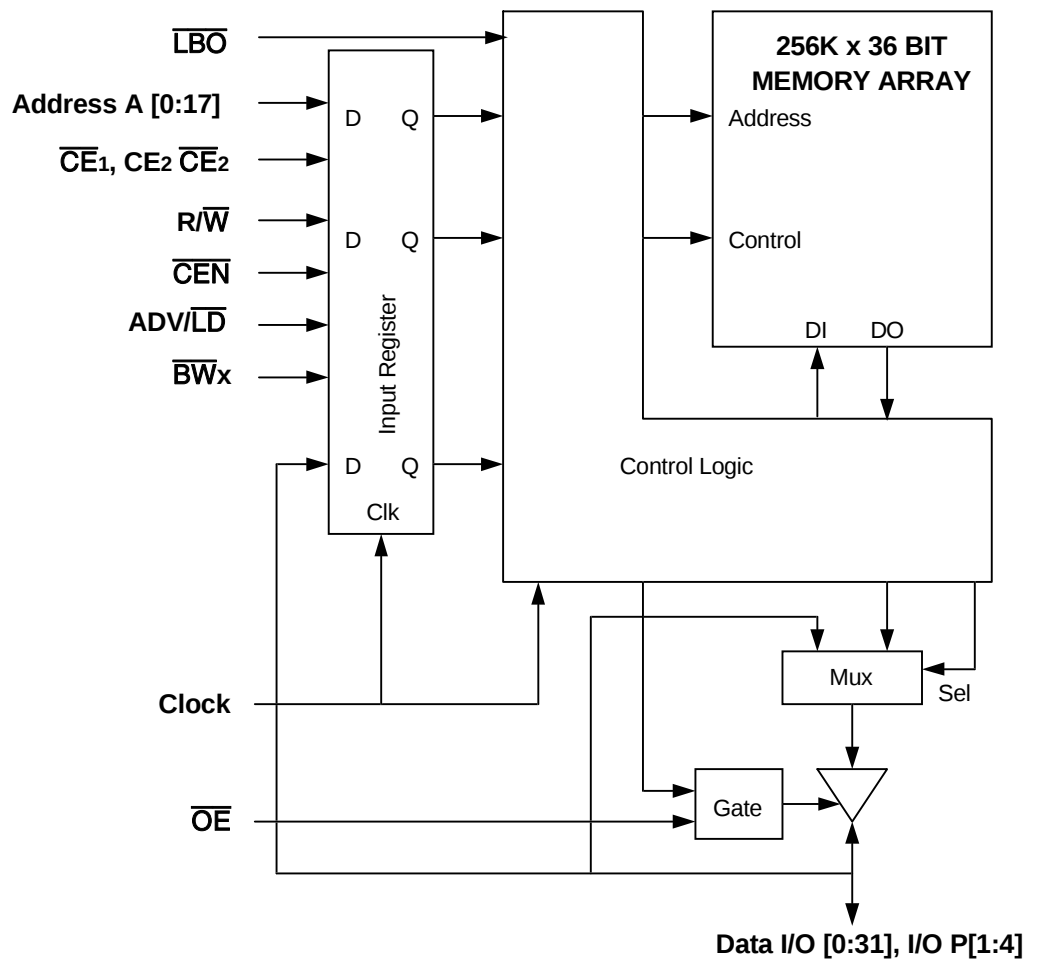
| Symbol                    | Pin Function                  | I/O | Active | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|---------------------------|-------------------------------|-----|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A0-A18                    | Address Inputs                | I   | N/A    | Synchronous Address inputs. The address register is triggered by a combination of the rising edge of CLK, ADV/LD low, CEN low, and true chip enables.                                                                                                                                                                                                                                                                                                                                                       |
| ADV/LD                    | Advance / Load                | I   | N/A    | ADV/LD is a synchronous input that is used to load the internal registers with new address and control when it is sampled low at the rising edge of clock with the chip selected. When ADV/LD is low with the chip deselected, any burst in progress is terminated. When ADV/LD is sampled high then the internal burst counter is advanced for any burst that was in progress. The external addresses are ignored when ADV/LD is sampled high.                                                             |
| R/W                       | Read / Write                  | I   | N/A    | R/W signal is a synchronous input that identifies whether the current load cycle initiated is a Read or Write access to the memory array. The data bus activity for the current cycle takes place one clock cycle later.                                                                                                                                                                                                                                                                                    |
| CEN                       | Clock Enable                  | I   | LOW    | Synchronous Clock Enable Input. When CEN is sampled high, all other synchronous inputs, including clock are ignored and outputs remain unchanged. The effect of CEN sampled high on the device outputs is as if the low to high clock transition did not occur. For normal operation, CEN must be sampled low at rising edge of clock.                                                                                                                                                                      |
| BW1-BW4                   | Individual Byte Write Enables | I   | LOW    | Synchronous byte write enables. Each 9-bit byte has its own active low byte write enable. On load write cycles (When R/W and ADV/LD are sampled low) the appropriate byte write signal (BW1-BW4) must be valid. The byte write signal must also be valid on each cycle of a burst write. Byte Write signals are ignored when R/W is sampled high. The appropriate byte(s) of data are written into the device one cycle later. BW1-BW4 can all be tied low if always doing write to the entire 36-bit word. |
| CE1, CE2                  | Chip Enables                  | I   | LOW    | Synchronous active low chip enable. CE1 and CE2 are used with CE2 to enable the IDT71V65703/5903 (CE1 or CE2 sampled high or CE2 sampled low) and ADV/LD low at the rising edge of clock, initiates a deselect cycle. The ZBT™ has a one cycle deselect, i.e., the data bus will tri-state one clock cycle after deselect is initiated.                                                                                                                                                                     |
| CE2                       | Chip Enable                   | I   | HIGH   | Synchronous active high chip enable. CE2 is used with CE1 and CE2 to enable the chip. CE2 has inverted polarity but otherwise identical to CE1 and CE2.                                                                                                                                                                                                                                                                                                                                                     |
| CLK                       | Clock                         | I   | N/A    | This is the clock input to the IDT71V65703/5903. Except for OE, all timing references for the device are made with respect to the rising edge of CLK.                                                                                                                                                                                                                                                                                                                                                       |
| I/O0-I/O31<br>I/OP1-I/OP4 | Data Input/Output             | I/O | N/A    | Data input/output (I/O) pins. The data input path is registered, triggered by the rising edge of CLK. The data output path is flow-through (no output register).                                                                                                                                                                                                                                                                                                                                            |
| LBO                       | Linear Burst Order            | I   | LOW    | Burst order selection input. When LBO is high the Interleaved burst sequence is selected. When LBO is low the Linear burst sequence is selected. LBO is a static input, and it must not change during device operation.                                                                                                                                                                                                                                                                                     |
| OE                        | Output Enable                 | I   | LOW    | Asynchronous output enable. OE must be low to read data from the 71V65703/5903. When OE is HIGH the I/O pins are in a high-impedance state. OE does not need to be actively controlled for read and write cycles. In normal operation, OE can be tied low.                                                                                                                                                                                                                                                  |
| ZZ                        | Sleep Mode                    | I   | HIGH   | Asynchronous sleep mode input. ZZ HIGH will gate the CLK internally and power down the IDT71V65703/5903 to its lowest power consumption level. Data retention is guaranteed in Sleep Mode.                                                                                                                                                                                                                                                                                                                  |
| VDD                       | Power Supply                  | N/A | N/A    | 3.3V core power supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| VDDQ                      | Power Supply                  | N/A | N/A    | 3.3V I/O supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| VSS                       | Ground                        | N/A | N/A    | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

### NOTE:

5298 tbl 02

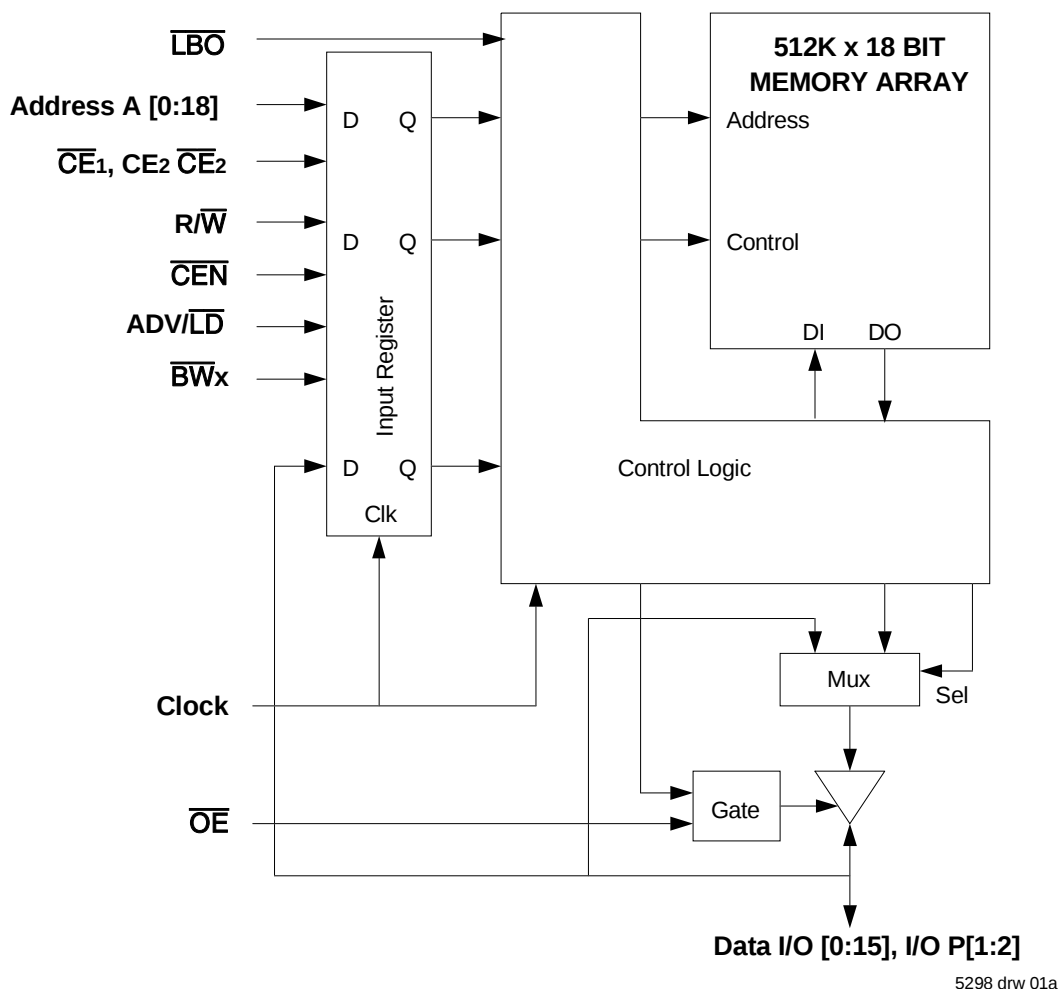
1. All synchronous inputs must meet specified setup and hold times with respect to CLK.

## Functional Block Diagram — 256K x 36



5298 drw 01

## Functional Block Diagram — 512K x 18



5298 drw 01a

## Recommended DC Operating Conditions

| Symbol           | Parameter                   | Min.                | Typ. | Max.                   | Unit |
|------------------|-----------------------------|---------------------|------|------------------------|------|
| V <sub>DD</sub>  | Core Supply Voltage         | 3.135               | 3.3  | 3.465                  | V    |
| V <sub>DDQ</sub> | I/O Supply Voltage          | 3.135               | 3.3  | 3.465                  | V    |
| V <sub>SS</sub>  | Ground                      | 0                   | 0    | 0                      | V    |
| V <sub>H</sub>   | Input High Voltage - Inputs | 2.0                 | —    | V <sub>DD</sub> + 0.3  | V    |
| V <sub>H</sub>   | Input High Voltage - I/O    | 2.0                 | —    | V <sub>DDQ</sub> + 0.3 | V    |
| V <sub>IL</sub>  | Input Low Voltage           | -0.3 <sup>(1)</sup> | —    | 0.8                    | V    |

5298 tbl 04

### NOTE:

1. V<sub>IL</sub> (min.) = -1.0V for pulse width less than t<sub>cy</sub>/2, once per cycle.

## Recommended Operating Temperature and Supply Voltage

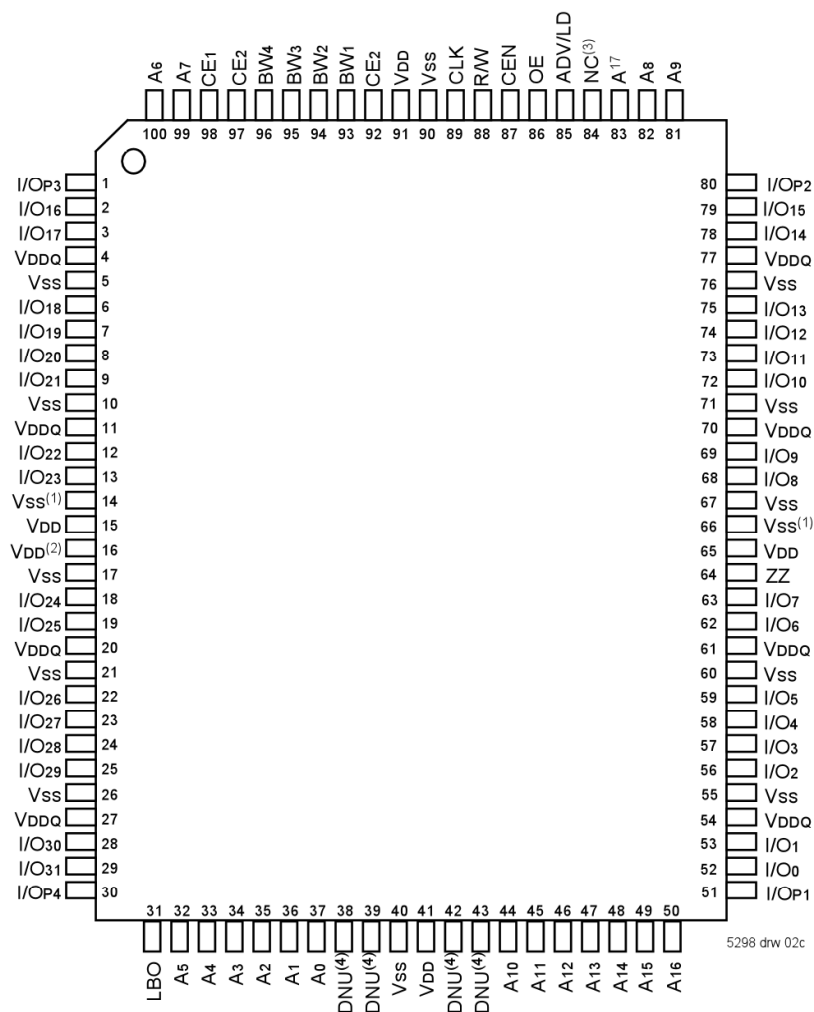
| Grade      | Temperature <sup>(1)</sup> | V <sub>SS</sub> | V <sub>DD</sub> | V <sub>DDQ</sub> |
|------------|----------------------------|-----------------|-----------------|------------------|
| Commercial | 0°C to +70°C               | 0V              | 3.3V±5%         | 3.3V±5%          |
| Industrial | -40°C to +85°C             | 0V              | 3.3V±5%         | 3.3V±5%          |

### NOTES:

5298 tbl 05

1. TA is the "instant on" case temperature.

## Pin Configuration — 256K x 36



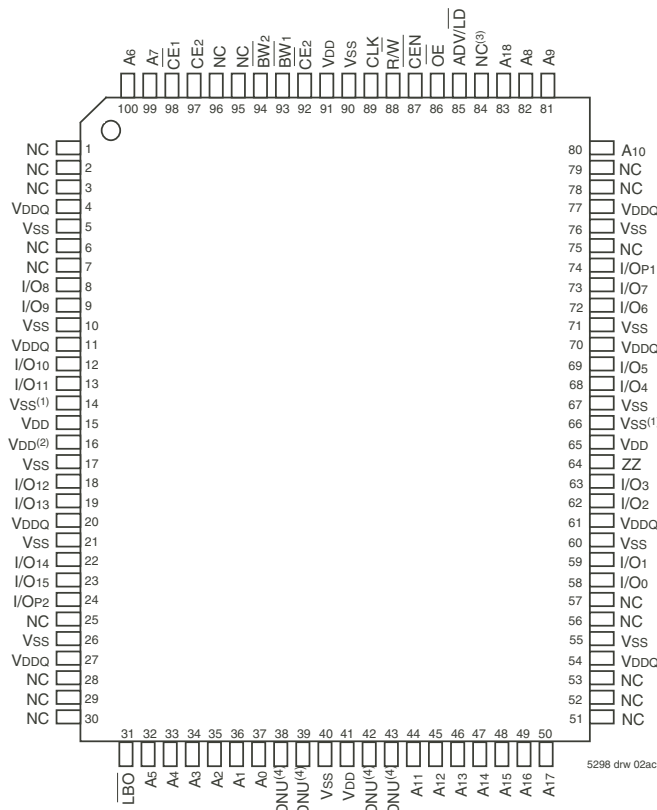
5298 drw 02c

## Top View 100 TQFP

### NOTES:

- Pins 14 and 66 do not have to be connected directly to V<sub>SS</sub> as long as the input voltage is  $\leq V_{IL}$ .
- Pin 16 does not have to be connected directly to V<sub>DD</sub> as long as the input voltage is  $\geq V_{IH}$ .
- Pins 84 is reserved for a future 16M.
- DNU = Do not use. Pins 38, 39, 42 and 43 are reserved for respective JTAG pins TMS, TDI, TDO and TCK. The current die revision allows these pins to be left unconnected, tied LOW (V<sub>SS</sub>), or tied HIGH (V<sub>DD</sub>).

## Pin Configuration — 512K x 18



### Top View 100 TQFP

#### NOTES:

- Pins 14 and 66 do not have to be connected directly to Vss as long as the input voltage is  $\leq V_{IL}$ .
- Pin 16 does not have to be connected directly to Vdd as long as the input voltage is  $\geq V_{IH}$ .
- Pin 84 is reserved for a future 16M.
- DNU = Do not use. Pins 38, 39, 42 and 43 are reserved for respective JTAG pins: TMS, TDI, TDO and TCK. The current die revision allows these pins to be left unconnected, tied LOW (Vss), or tied HIGH (Vdd).

### 100 TQFP Capacitance<sup>(1)</sup>

(TA = +25°C, f = 1.0MHz)

| Symbol           | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|------------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 3dV  | 5    | pF   |
| C <sub>I/O</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | 7    | pF   |

5298 tbl 07

### 165 fBGA Capacitance<sup>(1)</sup>

(TA = +25°C, f = 1.0MHz)

| Symbol           | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|------------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 3dV  | TBD  | pF   |
| C <sub>I/O</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | TBD  | pF   |

5298 tbl 07b

#### NOTE:

- This parameter is guaranteed by device characterization, but not production tested.

## Absolute Maximum Ratings<sup>(1)</sup>

| Symbol                             | Rating                               | Commercial & Industrial       | Unit |
|------------------------------------|--------------------------------------|-------------------------------|------|
| V <sub>TERM</sub> <sup>(2)</sup>   | Terminal Voltage with Respect to GND | -0.5 to +4.6                  | V    |
| V <sub>TERM</sub> <sup>(3,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DD</sub>       | V    |
| V <sub>TERM</sub> <sup>(4,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DD</sub> +0.5  | V    |
| V <sub>TERM</sub> <sup>(5,6)</sup> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DDQ</sub> +0.5 | V    |
| T <sub>A</sub> <sup>(7)</sup>      | Commercial                           | 0 to +70                      | °C   |
|                                    | Industrial                           | -40 to +85                    | °C   |
| T <sub>BIAS</sub>                  | Temperature Under Bias               | -55 to +125                   | °C   |
| T <sub>STG</sub>                   | Storage Temperature                  | -55 to +125                   | °C   |
| P <sub>T</sub>                     | Power Dissipation                    | 2.0                           | W    |
| I <sub>OUT</sub>                   | DC Output Current                    | 50                            | mA   |

5298 tbl 06

#### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V<sub>DD</sub> terminals only.
- V<sub>DDQ</sub> terminals only.
- Input terminals only.
- I/O terminals only.
- This is a steady-state DC parameter that applies after the power supply has reached its nominal operating value. Power sequencing is not necessary; however, the voltage on any input or I/O pin cannot exceed V<sub>DDQ</sub> during power supply ramp up.
- T<sub>A</sub> is the "instant on" case temperature.

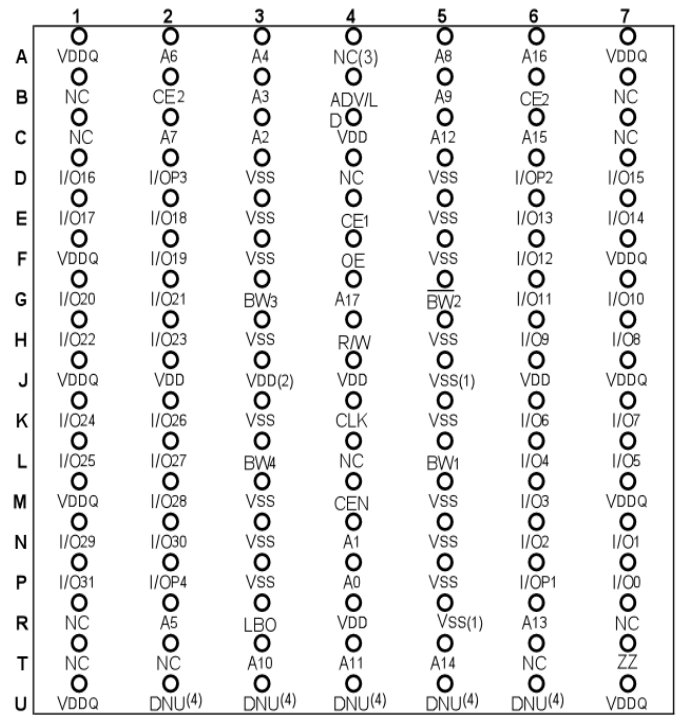
### 119 BGA Capacitance<sup>(1)</sup>

(TA = +25°C, f = 1.0MHz)

| Symbol           | Parameter <sup>(1)</sup> | Conditions             | Max. | Unit |
|------------------|--------------------------|------------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 3dV  | 7    | pF   |
| C <sub>I/O</sub> | I/O Capacitance          | V <sub>OUT</sub> = 3dV | 7    | pF   |

5298 tbl 07a

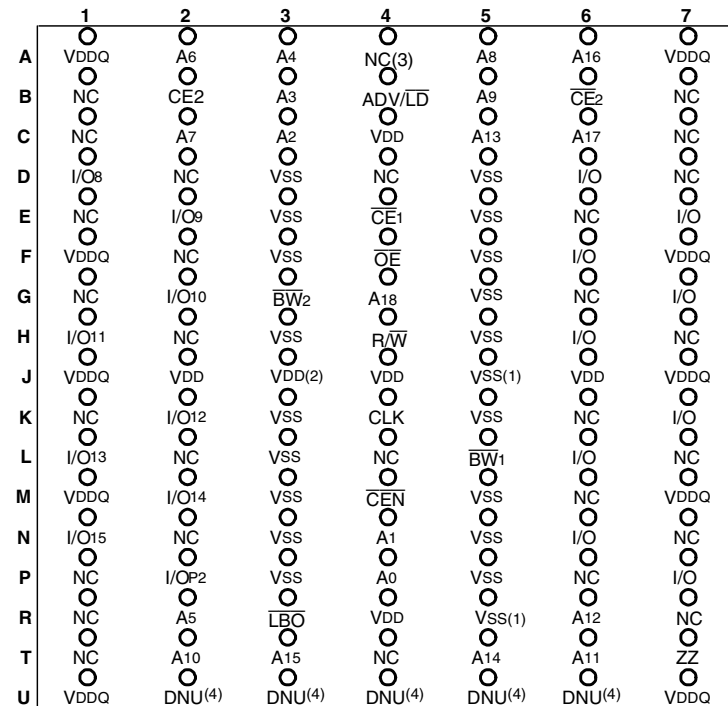
## Pin Configuration — 256K x 36, 119 BGA



Top View

5298 drw 13ac

## Pin Configuration — 512K x 18, 119 BGA



Top View

5298 drw 13bc

### NOTES:

1. R5 and J5 do not have to be directly connected to Vss as long as the input voltage is  $\leq V_{IL}$ .
2. J3 does not have to be connected directly to Vdd as long as the input voltage is  $\geq V_{IH}$ .
3. A4 is reserved for future 16M.
4. DNU = Do not use; Pin U2, U3, U4, U5 and U6 are reserved for respective JTAG pins: TMS, TDI, TCK, TDO and  $\overline{TRST}$ . The current die revision allows these pins to be left unconnected, tied LOW (Vss), or tied HIGH (Vdd).

## Pin Configuration — 256K x 36, 165 fBGA

|   | 1                  | 2                  | 3                | 4                | 5                  | 6                | 7                  | 8                    | 9                 | 10    | 11                |
|---|--------------------|--------------------|------------------|------------------|--------------------|------------------|--------------------|----------------------|-------------------|-------|-------------------|
| A | NC <sup>(3)</sup>  | A7                 | $\overline{CE}1$ | $\overline{BW}3$ | $\overline{BW}2$   | $\overline{CE}2$ | $\overline{CEN}$   | ADV/ $\overline{LD}$ | A17               | A8    | NC                |
| B | NC                 | A6                 | CE2              | $\overline{BW}4$ | $\overline{BW}1$   | CLK              | R/ $\overline{W}$  | $\overline{OE}$      | NC <sup>(3)</sup> | A9    | NC <sup>(3)</sup> |
| C | I/OP3              | NC                 | VDDQ             | VSS              | VSS                | VSS              | VSS                | VSS                  | VDDQ              | NC    | I/OP2             |
| D | I/O17              | I/O16              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O15 | I/O14             |
| E | I/O19              | I/O18              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O13 | I/O12             |
| F | I/O21              | I/O20              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O11 | I/O10             |
| G | I/O23              | I/O22              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O9  | I/O8              |
| H | VSS <sup>(1)</sup> | VDD <sup>(2)</sup> | NC               | VDD              | VSS                | VSS              | VSS                | VDD                  | NC                | NC    | ZZ                |
| J | I/O25              | I/O24              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O7  | I/O6              |
| K | I/O27              | I/O26              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O5  | I/O4              |
| L | I/O29              | I/O28              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O3  | I/O2              |
| M | I/O31              | I/O30              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O1  | I/O0              |
| N | I/OP4              | NC                 | VDDQ             | VSS              | DNU <sup>(4)</sup> | NC               | VSS <sup>(1)</sup> | VSS                  | VDDQ              | NC    | I/OP1             |
| P | NC                 | NC <sup>(3)</sup>  | A5               | A2               | DNU <sup>(4)</sup> | A1               | DNU <sup>(4)</sup> | A10                  | A13               | A14   | NC                |
| R | $\overline{LBO}$   | NC <sup>(3)</sup>  | A4               | A3               | DNU <sup>(4)</sup> | A0               | DNU <sup>(4)</sup> | A11                  | A12               | A15   | A16               |

5298 tbl 25a

## Pin Configuration — 512K x 18, 165 fBGA

|   | 1                  | 2                  | 3                | 4                | 5                  | 6                | 7                  | 8                    | 9                 | 10   | 11                |
|---|--------------------|--------------------|------------------|------------------|--------------------|------------------|--------------------|----------------------|-------------------|------|-------------------|
| A | NC <sup>(3)</sup>  | A7                 | $\overline{CE}1$ | $\overline{BW}2$ | NC                 | $\overline{CE}2$ | $\overline{CEN}$   | ADV/ $\overline{LD}$ | A18               | A8   | A10               |
| B | NC                 | A6                 | CE2              | NC               | $\overline{BW}1$   | CLK              | R/ $\overline{W}$  | $\overline{OE}$      | NC <sup>(3)</sup> | A9   | NC <sup>(3)</sup> |
| C | NC                 | NC                 | VDDQ             | VSS              | VSS                | VSS              | VSS                | VSS                  | VDDQ              | NC   | I/OP1             |
| D | NC                 | I/O8               | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | NC   | I/O7              |
| E | NC                 | I/O9               | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | NC   | I/O6              |
| F | NC                 | I/O10              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | NC   | I/O5              |
| G | NC                 | I/O11              | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | NC   | I/O4              |
| H | VSS <sup>(1)</sup> | VDD <sup>(2)</sup> | NC               | VDD              | VSS                | VSS              | VSS                | VDD                  | NC                | NC   | ZZ                |
| J | I/O12              | NC                 | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O3 | NC                |
| K | I/O13              | NC                 | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O2 | NC                |
| L | I/O14              | NC                 | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O1 | NC                |
| M | I/O15              | NC                 | VDDQ             | VDD              | VSS                | VSS              | VSS                | VDD                  | VDDQ              | I/O0 | NC                |
| N | I/OP2              | NC                 | VDDQ             | VSS              | DNU <sup>(4)</sup> | NC               | VSS <sup>(1)</sup> | VSS                  | VDDQ              | NC   | NC                |
| P | NC                 | NC <sup>(3)</sup>  | A5               | A2               | DNU <sup>(4)</sup> | A1               | DNU <sup>(4)</sup> | A11                  | A14               | A15  | NC                |
| R | $\overline{LBO}$   | NC <sup>(3)</sup>  | A4               | A3               | DNU <sup>(4)</sup> | A0               | DNU <sup>(4)</sup> | A12                  | A13               | A16  | A17               |

5298 tbl 25b

### NOTES:

1. Pins H1 and N7 do not have to be connected directly to Vss as long as the input voltage is  $\leq V_{IL}$ .
2. Pin H2 does not have to be connected directly to VDD as long as the input voltage is  $\geq V_{IH}$ .
3. Pin B9, B11, A1, R2 and P2 are reserved for a future 18M, 36M, 72M, 144M and 288M respectively.
4. DNU = Do not use. Pins P5, R5, P7, R7 and N5 are reserved for respective JTAG pins: TDI, TMS, TDO, TCK and  $\overline{TRST}$  on future revisions. The current die revision allows these pins to be left unconnected, tied LOW (Vss), or tied HIGH (VDD).

## Synchronous Truth Table<sup>(1)</sup>

| $\overline{\text{CEN}}$ | R/W | $\overline{\text{CE}}_1, \overline{\text{CE}}_2^{(5)}$ | ADV/LD | BWx   | ADDRESS USED | PREVIOUS CYCLE              | CURRENT CYCLE                                         | I/O<br>(One cycle later) |
|-------------------------|-----|--------------------------------------------------------|--------|-------|--------------|-----------------------------|-------------------------------------------------------|--------------------------|
| L                       | L   | L                                                      | L      | Valid | External     | X                           | LOAD WRITE                                            | D <sup>(7)</sup>         |
| L                       | H   | L                                                      | L      | X     | External     | X                           | LOAD READ                                             | Q <sup>(7)</sup>         |
| L                       | X   | X                                                      | H      | Valid | Internal     | LOAD WRITE /<br>BURST WRITE | BURST WRITE<br>(Advance burst counter) <sup>(2)</sup> | D <sup>(7)</sup>         |
| L                       | X   | X                                                      | H      | X     | Internal     | LOAD READ /<br>BURST READ   | BURST READ<br>(Advance burst counter) <sup>(2)</sup>  | Q <sup>(7)</sup>         |
| L                       | X   | H                                                      | L      | X     | X            | X                           | DESELECT or STOP <sup>(3)</sup>                       | HIZ                      |
| L                       | X   | X                                                      | H      | X     | X            | DESELECT / NOOP             | NOOP                                                  | HIZ                      |
| H                       | X   | X                                                      | X      | X     | X            | X                           | SUSPEND <sup>(4)</sup>                                | Previous Value           |

5298 tbl 08

### NOTES:

1. L = V<sub>IL</sub>, H = V<sub>IH</sub>, X = Don't Care.
2. When ADV/LD signal is sampled high, the internal burst counter is incremented. The R/W signal is ignored when the counter is advanced. Therefore the nature of the burst cycle (Read or Write) is determined by the status of the R/W signal when the first address is loaded at the beginning of the burst cycle.
3. Deselect cycle is initiated when either ( $\overline{\text{CE}}_1$ , or  $\overline{\text{CE}}_2$  is sampled high or CE2 is sampled low) and ADV/LD is sampled low at rising edge of clock. The data bus will tri-state one cycle after deselect is initiated.
4. When  $\overline{\text{CEN}}$  is sampled high at the rising edge of clock, that clock edge is blocked from propagating through the part. The state of all the internal registers and the I/Os remains unchanged.
5. To select the chip requires  $\overline{\text{CE}}_1 = \text{L}$ ,  $\overline{\text{CE}}_2 = \text{L}$  and CE2 = H on these chip enable pins. The chip is deselected if any one of the chip enables is false.
6. Device Outputs are ensured to be in High-Z during device power-up.
7. Q - data read from the device, D - data written to the device.

## Partial Truth Table for Writes<sup>(1)</sup>

| OPERATION                                         | R/W | $\overline{\text{BW}}_1$ | $\overline{\text{BW}}_2$ | $\overline{\text{BW}}_3^{(3)}$ | $\overline{\text{BW}}_4^{(3)}$ |
|---------------------------------------------------|-----|--------------------------|--------------------------|--------------------------------|--------------------------------|
| READ                                              | H   | X                        | X                        | X                              | X                              |
| WRITE ALL BYTES                                   | L   | L                        | L                        | L                              | L                              |
| WRITE BYTE 1 (I/O[0:7], I/OP1) <sup>(2)</sup>     | L   | L                        | H                        | H                              | H                              |
| WRITE BYTE 2 (I/O[8:15], I/OP2) <sup>(2)</sup>    | L   | H                        | L                        | H                              | H                              |
| WRITE BYTE 3 (I/O[16:23], I/OP3) <sup>(2,3)</sup> | L   | H                        | H                        | L                              | H                              |
| WRITE BYTE 4 (I/O[24:31], I/OP4) <sup>(2,3)</sup> | L   | H                        | H                        | H                              | L                              |
| NO WRITE                                          | L   | H                        | H                        | H                              | H                              |

5298 tbl 09

### NOTES:

1. L = V<sub>IL</sub>, H = V<sub>IH</sub>, X = Don't Care.
2. Multiple bytes may be selected during the same cycle.
3. N/A for x18 configuration.

## Interleaved Burst Sequence Table ( $\overline{\text{LBO}} = \text{VDD}$ )

|                               | Sequence 1 |    | Sequence 2 |    | Sequence 3 |    | Sequence 4 |    |
|-------------------------------|------------|----|------------|----|------------|----|------------|----|
|                               | A1         | A0 | A1         | A0 | A1         | A0 | A1         | A0 |
| First Address                 | 0          | 0  | 0          | 1  | 1          | 0  | 1          | 1  |
| Second Address                | 0          | 1  | 0          | 0  | 1          | 1  | 1          | 0  |
| Third Address                 | 1          | 0  | 1          | 1  | 0          | 0  | 0          | 1  |
| Fourth Address <sup>(1)</sup> | 1          | 1  | 1          | 0  | 0          | 1  | 0          | 0  |

5298 tbl 10

### NOTE:

1. Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

## Linear Burst Sequence Table ( $\overline{\text{LB}}\overline{\text{O}}=\text{Vss}$ )

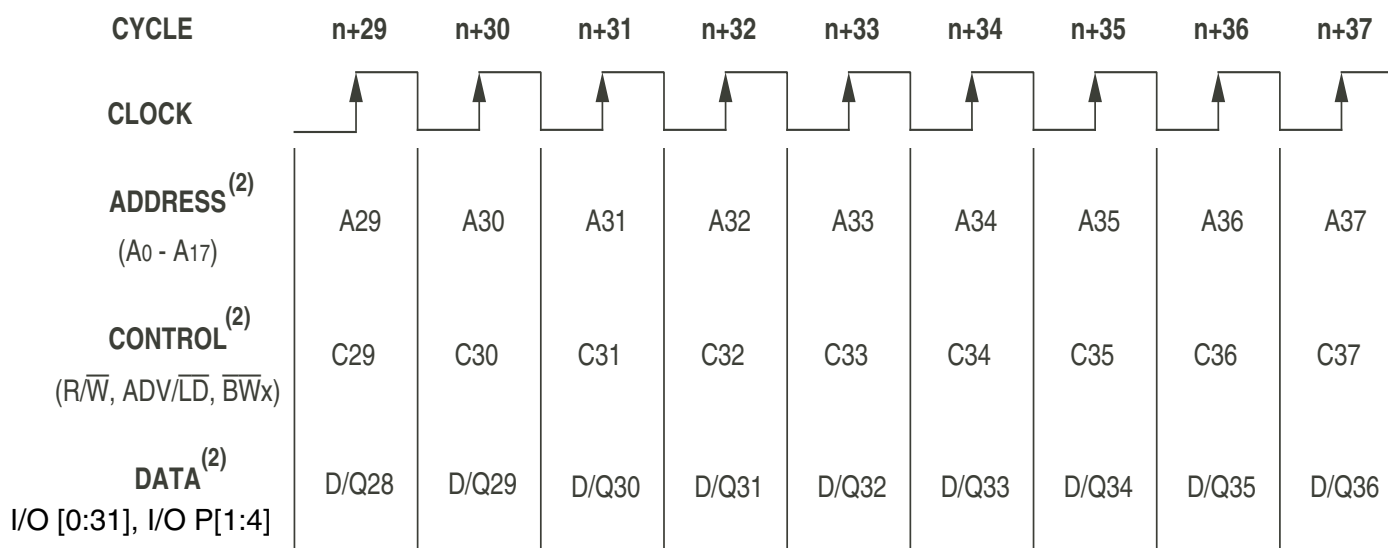
|                               | Sequence 1 |    | Sequence 2 |    | Sequence 3 |    | Sequence 4 |    |
|-------------------------------|------------|----|------------|----|------------|----|------------|----|
|                               | A1         | A0 | A1         | A0 | A1         | A0 | A1         | A0 |
| First Address                 | 0          | 0  | 0          | 1  | 1          | 0  | 1          | 1  |
| Second Address                | 0          | 1  | 1          | 0  | 1          | 1  | 0          | 0  |
| Third Address                 | 1          | 0  | 1          | 1  | 0          | 0  | 0          | 1  |
| Fourth Address <sup>(1)</sup> | 1          | 1  | 0          | 0  | 0          | 1  | 1          | 0  |

5298 tbl 11

### NOTE:

1. Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

## Functional Timing Diagram<sup>(1)</sup>



5298 drw 03c

### NOTES:

1. This assumes  $\overline{\text{CEN}}$ ,  $\overline{\text{CE}}_1$ ,  $\text{CE}_2$  and  $\overline{\text{CE}}_2$  are all true.
2. All Address, Control and Data\_In are only required to meet set-up and hold time with respect to the rising edge of clock. Data\_Out is valid after a clock-to-data delay from the rising edge of clock.

## Device Operation - Showing Mixed Load, Burst, Deselect and NOOP Cycles<sup>(2)</sup>

| Cycle | Address | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(1)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O  | Comments         |
|-------|---------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|------|------------------|
| n     | A0      | H                 | L                    | L                       | L                | X                 | X               | D1   | Load read        |
| n+1   | X       | X                 | H                    | X                       | L                | X                 | L               | Q0   | Burst read       |
| n+2   | A1      | H                 | L                    | L                       | L                | X                 | L               | Q0+1 | Load read        |
| n+3   | X       | X                 | L                    | H                       | L                | X                 | L               | Q1   | Deselect or STOP |
| n+4   | X       | X                 | H                    | X                       | L                | X                 | X               | Z    | NOOP             |
| n+5   | A2      | H                 | L                    | L                       | L                | X                 | X               | Z    | Load read        |
| n+6   | X       | X                 | H                    | X                       | L                | X                 | L               | Q2   | Burst read       |
| n+7   | X       | X                 | L                    | H                       | L                | X                 | L               | Q2+1 | Deselect or STOP |
| n+8   | A3      | L                 | L                    | L                       | L                | L                 | X               | Z    | Load write       |
| n+9   | X       | X                 | H                    | X                       | L                | L                 | X               | D3   | Burst write      |
| n+10  | A4      | L                 | L                    | L                       | L                | L                 | X               | D3+1 | Load write       |
| n+11  | X       | X                 | L                    | H                       | L                | X                 | X               | D4   | Deselect or STOP |
| n+12  | X       | X                 | H                    | X                       | L                | X                 | X               | Z    | NOOP             |
| n+13  | A5      | L                 | L                    | L                       | L                | L                 | X               | Z    | Load write       |
| n+14  | A6      | H                 | L                    | L                       | L                | X                 | X               | D5   | Load read        |
| n+15  | A7      | L                 | L                    | L                       | L                | L                 | L               | Q6   | Load write       |
| n+16  | X       | X                 | H                    | X                       | L                | L                 | X               | D7   | Burst write      |
| n+17  | A8      | H                 | L                    | L                       | L                | X                 | X               | D7+1 | Load read        |
| n+18  | X       | X                 | H                    | X                       | L                | X                 | L               | Q8   | Burst read       |
| n+19  | A9      | L                 | L                    | L                       | L                | L                 | L               | Q8+1 | Load write       |

5298 tbl 12

### NOTES:

- $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.
- H = High; L = Low; X = Don't Care; Z = High Impedence.

## Read Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                                    |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|----------------|---------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                       | L                | X                 | X               | X              | Address and Control meet setup              |
| n+1   | X              | X                 | X                    | X                       | X                | X                 | L               | Q <sub>0</sub> | Contents of Address A <sub>0</sub> Read Out |

### NOTES:

5298 tbl 13

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Burst Read Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O              | Comments                                               |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|------------------|--------------------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                       | L                | X                 | X               | X                | Address and Control meet setup                         |
| n+1   | X              | X                 | H                    | X                       | L                | X                 | L               | Q <sub>0</sub>   | Address A <sub>0</sub> Read Out, Inc. Count            |
| n+2   | X              | X                 | H                    | X                       | L                | X                 | L               | Q <sub>0+1</sub> | Address A <sub>0+1</sub> Read Out, Inc. Count          |
| n+3   | X              | X                 | H                    | X                       | L                | X                 | L               | Q <sub>0+2</sub> | Address A <sub>0+2</sub> Read Out, Inc. Count          |
| n+4   | X              | X                 | H                    | X                       | L                | X                 | L               | Q <sub>0+3</sub> | Address A <sub>0+3</sub> Read Out, Load A <sub>1</sub> |
| n+5   | A <sub>1</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>0</sub>   | Address A <sub>0</sub> Read Out, Inc. Count            |
| n+6   | X              | X                 | H                    | X                       | L                | X                 | L               | Q <sub>1</sub>   | Address A <sub>1</sub> Read Out, Inc. Count            |
| n+7   | A <sub>2</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>1+1</sub> | Address A <sub>1+1</sub> Read Out, Load A <sub>2</sub> |

### NOTES:

5298 tbl 14

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Write Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                        |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|----------------|---------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                       | L                | L                 | X               | X              | Address and Control meet setup  |
| n+1   | X              | X                 | X                    | X                       | L                | X                 | X               | D <sub>0</sub> | Write to Address A <sub>0</sub> |

### NOTES:

5298 tbl 15

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Burst Write Operation<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O              | Comments                                            |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|------------------|-----------------------------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                       | L                | L                 | X               | X                | Address and Control meet setup                      |
| n+1   | X              | X                 | H                    | X                       | L                | L                 | X               | D <sub>0</sub>   | Address A <sub>0</sub> Write, Inc. Count            |
| n+2   | X              | X                 | H                    | X                       | L                | L                 | X               | D <sub>0+1</sub> | Address A <sub>0+1</sub> Write, Inc. Count          |
| n+3   | X              | X                 | H                    | X                       | L                | L                 | X               | D <sub>0+2</sub> | Address A <sub>0+2</sub> Write, Inc. Count          |
| n+4   | X              | X                 | H                    | X                       | L                | L                 | X               | D <sub>0+3</sub> | Address A <sub>0+3</sub> Write, Load A <sub>1</sub> |
| n+5   | A <sub>1</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>0</sub>   | Address A <sub>0</sub> Write, Inc. Count            |
| n+6   | X              | X                 | H                    | X                       | L                | L                 | X               | D <sub>1</sub>   | Address A <sub>1</sub> Write, Inc. Count            |
| n+7   | A <sub>2</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>1+1</sub> | Address A <sub>1+1</sub> Write, Load A <sub>2</sub> |

### NOTES:

5298 tbl 16

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Read Operation with Clock Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                                             |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|----------------|------------------------------------------------------|
| n     | A <sub>0</sub> | H                 | L                    | L                       | L                | X                 | X               | X              | Address A <sub>0</sub> and Control meet setup        |
| n+1   | X              | X                 | X                    | X                       | H                | X                 | X               | X              | Clock n+1 Ignored                                    |
| n+2   | A <sub>1</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>0</sub> | Address A <sub>0</sub> Read out, Load A <sub>1</sub> |
| n+3   | X              | X                 | X                    | X                       | H                | X                 | L               | Q <sub>0</sub> | Clock Ignored. Data Q <sub>0</sub> is on the bus.    |
| n+4   | X              | X                 | X                    | X                       | H                | X                 | L               | Q <sub>0</sub> | Clock Ignored. Data Q <sub>0</sub> is on the bus.    |
| n+5   | A <sub>2</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>1</sub> | Address A <sub>1</sub> Read out, Load A <sub>2</sub> |
| n+6   | A <sub>3</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>2</sub> | Address A <sub>2</sub> Read out, Load A <sub>3</sub> |
| n+7   | A <sub>4</sub> | H                 | L                    | L                       | L                | X                 | L               | Q <sub>3</sub> | Address A <sub>3</sub> Read out, Load A <sub>4</sub> |

5298 tbl 17

### NOTES:

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Write Operation with Clock Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                                          |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|----------------|---------------------------------------------------|
| n     | A <sub>0</sub> | L                 | L                    | L                       | L                | L                 | X               | X              | Address A <sub>0</sub> and Control meet setup.    |
| n+1   | X              | X                 | X                    | X                       | H                | X                 | X               | X              | Clock n+1 Ignored.                                |
| n+2   | A <sub>1</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>0</sub> | Write data D <sub>0</sub> , Load A <sub>1</sub> . |
| n+3   | X              | X                 | X                    | X                       | H                | X                 | X               | X              | Clock Ignored.                                    |
| n+4   | X              | X                 | X                    | X                       | H                | X                 | X               | X              | Clock Ignored.                                    |
| n+5   | A <sub>2</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>1</sub> | Write Data D <sub>1</sub> , Load A <sub>2</sub>   |
| n+6   | A <sub>3</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>2</sub> | Write Data D <sub>2</sub> , Load A <sub>3</sub>   |
| n+7   | A <sub>4</sub> | L                 | L                    | L                       | L                | L                 | X               | D <sub>3</sub> | Write Data D <sub>3</sub> , Load A <sub>4</sub>   |

5298 tbl 18

### NOTES:

1. H = High; L = Low; X = Don't Care; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.

## Read Operation with Chip Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O <sup>(3)</sup> | Comments                                       |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|--------------------|------------------------------------------------|
| n     | X              | X                 | L                    | H                       | L                | X                 | X               | ?                  | Deselected.                                    |
| n+1   | X              | X                 | L                    | H                       | L                | X                 | X               | Z                  | Deselected.                                    |
| n+2   | A <sub>0</sub> | H                 | L                    | L                       | L                | X                 | X               | Z                  | Address A <sub>0</sub> and Control meet setup. |
| n+3   | X              | X                 | L                    | H                       | L                | X                 | L               | Q <sub>0</sub>     | Address A <sub>0</sub> read out, Deselected.   |
| n+4   | A <sub>1</sub> | H                 | L                    | L                       | L                | X                 | X               | Z                  | Address A <sub>1</sub> and Control meet setup. |
| n+5   | X              | X                 | L                    | H                       | L                | X                 | L               | Q <sub>1</sub>     | Address A <sub>1</sub> read out, Deselected.   |
| n+6   | X              | X                 | L                    | H                       | L                | X                 | X               | Z                  | Deselected.                                    |
| n+7   | A <sub>2</sub> | H                 | L                    | L                       | L                | X                 | X               | Z                  | Address A <sub>2</sub> and Control meet setup. |
| n+8   | X              | X                 | L                    | H                       | L                | X                 | L               | Q <sub>2</sub>     | Address A <sub>2</sub> read out, Deselected.   |
| n+9   | X              | X                 | L                    | H                       | L                | X                 | X               | Z                  | Deselected.                                    |

5298 tbl 19

### NOTES:

1. H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
2.  $\overline{CE}_2$  timing transition is identical to  $\overline{CE}_1$  signal.  $\overline{CE}_2$  timing transition is identical but inverted to the  $\overline{CE}_1$  and  $\overline{CE}_2$  signals.
3. Device outputs are ensured to be in High-Z during device power-up.

## Write Operation with Chip Enable Used<sup>(1)</sup>

| Cycle | Address        | R/ $\overline{W}$ | ADV/ $\overline{LD}$ | $\overline{CE}_1^{(2)}$ | $\overline{CEN}$ | $\overline{BW}_x$ | $\overline{OE}$ | I/O            | Comments                                      |
|-------|----------------|-------------------|----------------------|-------------------------|------------------|-------------------|-----------------|----------------|-----------------------------------------------|
| n     | X              | X                 | L                    | H                       | L                | X                 | X               | ?              | Deselected.                                   |
| n+1   | X              | X                 | L                    | H                       | L                | X                 | X               | Z              | Deselected.                                   |
| n+2   | A <sub>0</sub> | L                 | L                    | L                       | L                | L                 | X               | Z              | Address A <sub>0</sub> and Control meet setup |
| n+3   | X              | X                 | L                    | H                       | L                | X                 | X               | D <sub>0</sub> | Data D <sub>0</sub> Write In, Deselected.     |
| n+4   | A <sub>1</sub> | L                 | L                    | L                       | L                | L                 | X               | Z              | Address A <sub>1</sub> and Control meet setup |
| n+5   | X              | X                 | L                    | H                       | L                | X                 | X               | D <sub>1</sub> | Data D <sub>1</sub> Write In, Deselected.     |
| n+6   | X              | X                 | L                    | H                       | L                | X                 | X               | Z              | Deselected.                                   |
| n+7   | A <sub>2</sub> | L                 | L                    | L                       | L                | L                 | X               | Z              | Address A <sub>2</sub> and Control meet setup |
| n+8   | X              | X                 | L                    | H                       | L                | X                 | X               | D <sub>2</sub> | Data D <sub>2</sub> Write In, Deselected.     |
| n+9   | X              | X                 | L                    | H                       | L                | X                 | X               | Z              | Deselected.                                   |

5298 tbl 20

### NOTES:

1. H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
2.  $\overline{CE} = L$  is defined as  $\overline{CE}_1 = L$ ,  $\overline{CE}_2 = L$  and  $CE_2 = H$ .  $\overline{CE} = H$  is defined as  $\overline{CE}_1 = H$ ,  $\overline{CE}_2 = H$  or  $CE_2 = L$ .

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range ( $V_{DD} = 3.3V \pm 5\%$ )

| Symbol     | Parameter                                             | Test Conditions                                        | Min. | Max. | Unit    |
|------------|-------------------------------------------------------|--------------------------------------------------------|------|------|---------|
| $ I_{LI} $ | Input Leakage Current                                 | $V_{DD} = \text{Max.}, V_{IN} = 0V \text{ to } V_{DD}$ | —    | 5    | $\mu A$ |
| $ I_{LI} $ | $\overline{LBO}$ Input Leakage Current <sup>(1)</sup> | $V_{DD} = \text{Max.}, V_{IN} = 0V \text{ to } V_{DD}$ | —    | 30   | $\mu A$ |
| $ I_{LO} $ | Output Leakage Current                                | $V_{OUT} = 0V \text{ to } V_{CC}$                      | —    | 5    | $\mu A$ |
| $V_{OL}$   | Output Low Voltage                                    | $I_{OL} = +8mA, V_{DD} = \text{Min.}$                  | —    | 0.4  | V       |
| $V_{OH}$   | Output High Voltage                                   | $I_{OH} = -8mA, V_{DD} = \text{Min.}$                  | 2.4  | —    | V       |

NOTE:

5298 tbl 21

1. The  $\overline{LBO}$  pin will be internally pulled to  $V_{DD}$  if it is not actively driven in the application and the ZZ pin will be internally pulled to  $V_{SS}$  if not actively driven.

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range<sup>(1)</sup> ( $V_{DD} = 3.3V \pm 5\%$ )

| Symbol    | Parameter                          | Test Conditions                                                                                                                                                    | 7.5ns |     | 8ns   |     | 8.5ns |     | Unit |
|-----------|------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-----|-------|-----|-------|-----|------|
|           |                                    |                                                                                                                                                                    | Com'l | Ind | Com'l | Ind | Com'l | Ind |      |
| $I_{DD}$  | Operating Power Supply Current     | Device Selected, Outputs Open, $ADV/\overline{LD} = X, V_{DD} = \text{Max.}, V_{IN} \geq V_{IH} \text{ or } \leq V_{IL}, f = f_{MAX}^{(2)}$                        | 275   | 295 | 250   | 270 | 225   | 245 | mA   |
| $I_{SB1}$ | CMOS Standby Power Supply Current  | Device Deselected, Outputs Open, $V_{DD} = \text{Max.}, V_{IN} \geq V_{HD} \text{ or } \leq V_{LD}, f = 0^{(2,3)}$                                                 | 40    | 60  | 40    | 60  | 40    | 60  | mA   |
| $I_{SB2}$ | Clock Running Power Supply Current | Device Deselected, Outputs Open, $V_{DD} = \text{Max.}, V_{IN} \geq V_{HD} \text{ or } \leq V_{LD}, f = f_{MAX}^{(2,3)}$                                           | 105   | 125 | 100   | 120 | 95    | 115 | mA   |
| $I_{SB3}$ | Idle Power Supply Current          | Device Selected, Outputs Open, $\overline{CEN} \geq V_{IH}, V_{DD} = \text{Max.}, V_{IN} \geq V_{HD} \text{ or } \leq V_{LD}, f = f_{MAX}^{(2,3)}$                 | 40    | 60  | 40    | 60  | 40    | 60  | mA   |
| $I_{ZZ}$  | Full Sleep Mode Supply Current     | Device Selected, Outputs Open, $\overline{CEN} \leq V_{IL}, V_{DD} = \text{Max.}, ZZ \geq V_{HD}, V_{IN} \geq V_{HD} \text{ or } \leq V_{LD}, f = f_{MAX}^{(2,3)}$ | 40    | 60  | 40    | 60  | 40    | 60  | mA   |

NOTES:

5298 tbl 22

- All values are maximum guaranteed values.
- At  $f = f_{MAX}$ , inputs are cycling at the maximum frequency of read cycles of  $1/t_{CYC}$ ;  $f=0$  means no input lines are changing.
- For I/Os  $V_{HD} = V_{DDQ} - 0.2V, V_{LD} = 0.2V$ . For other inputs  $V_{HD} = V_{DD} - 0.2V, V_{LD} = 0.2V$ .

## AC Test Load

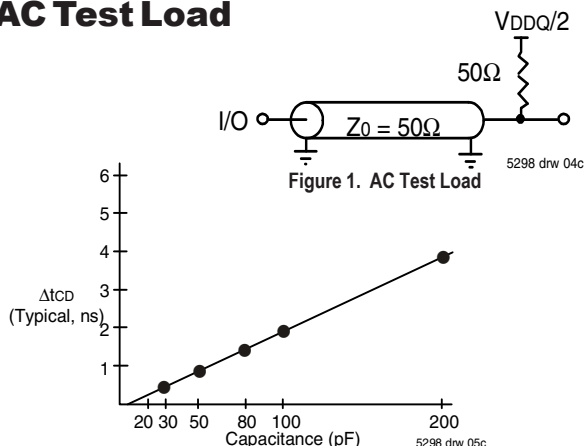


Figure 2. Lumped Capacitive Load, Typical Derating

## AC Test Conditions

|                               |          |
|-------------------------------|----------|
| Input Pulse Levels            | 0 to 3V  |
| Input Rise/Fall Times         | 2ns      |
| Input Timing Reference Levels | 1.5V     |
| Output Reference Levels       | 1.5V     |
| Output Load                   | Figure 1 |

5298 tbl 23

## AC Electrical Characteristics

(VDD = 3.3V±5%, Commercial and Industrial Temperature Ranges)

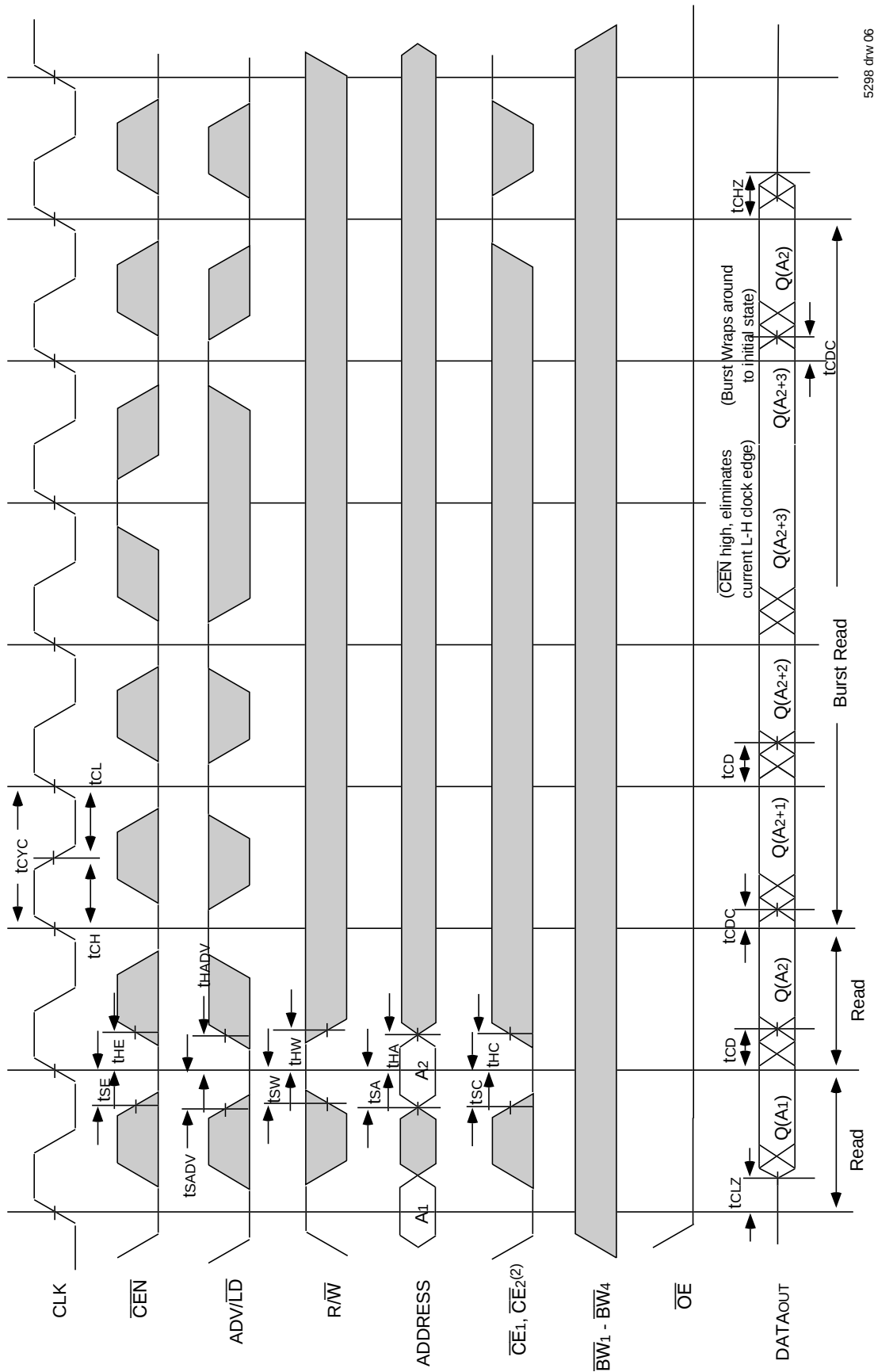
| Symbol                              | Parameter                          | 7.5ns |      | 8ns  |      | 8.5ns |      | Unit |
|-------------------------------------|------------------------------------|-------|------|------|------|-------|------|------|
|                                     |                                    | Min.  | Max. | Min. | Max. | Min.  | Max. |      |
| t <sub>CYC</sub>                    | Clock Cycle Time                   | 10    | —    | 10.5 | —    | 11    | —    | ns   |
| t <sub>CH</sub> <sup>(1)</sup>      | Clock High Pulse Width             | 2.5   | —    | 2.7  | —    | 3.0   | —    | ns   |
| t <sub>CL</sub> <sup>(1)</sup>      | Clock Low Pulse Width              | 2.5   | —    | 2.7  | —    | 3.0   | —    | ns   |
| <b>Output Parameters</b>            |                                    |       |      |      |      |       |      |      |
| t <sub>CD</sub>                     | Clock High to Valid Data           | —     | 7.5  | —    | 8    | —     | 8.5  | ns   |
| t <sub>ODC</sub>                    | Clock High to Data Change          | 2     | —    | 2    | —    | 2     | —    | ns   |
| t <sub>OLZ</sub> <sup>(2,3,4)</sup> | Clock High to Output Active        | 3     | —    | 3    | —    | 3     | —    | ns   |
| t <sub>CHZ</sub> <sup>(2,3,4)</sup> | Clock High to Data High-Z          | —     | 5    | —    | 5    | —     | 5    | ns   |
| t <sub>OE</sub>                     | Output Enable Access Time          | —     | 5    | —    | 5    | —     | 5    | ns   |
| t <sub>OLZ</sub> <sup>(2,3)</sup>   | Output Enable Low to Data Active   | 0     | —    | 0    | —    | 0     | —    | ns   |
| t <sub>OHZ</sub> <sup>(2,3)</sup>   | Output Enable High to Data High-Z  | —     | 5    | —    | 5    | —     | 5    | ns   |
| <b>Set Up Times</b>                 |                                    |       |      |      |      |       |      |      |
| t <sub>SE</sub>                     | Clock Enable Setup Time            | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>SA</sub>                     | Address Setup Time                 | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>SD</sub>                     | Data In Setup Time                 | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>SW</sub>                     | Read/Write (R/W) Setup Time        | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>ADV</sub>                    | Advance/Load (ADV/LD) Setup Time   | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>SC</sub>                     | Chip Enable/Select Setup Time      | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| t <sub>SB</sub>                     | Byte Write Enable (BWx) Setup Time | 2.0   | —    | 2.0  | —    | 2.0   | —    | ns   |
| <b>Hold Times</b>                   |                                    |       |      |      |      |       |      |      |
| t <sub>HE</sub>                     | Clock Enable Hold Time             | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HA</sub>                     | Address Hold Time                  | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HD</sub>                     | Data In Hold Time                  | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HW</sub>                     | Read/Write (R/W) Hold Time         | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HADV</sub>                   | Advance/Load (ADV/LD) Hold Time    | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HC</sub>                     | Chip Enable/Select Hold Time       | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |
| t <sub>HB</sub>                     | Byte Write Enable (BWx) Hold Time  | 0.5   | —    | 0.5  | —    | 0.5   | —    | ns   |

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### NOTES:

1. Measured as HIGH above 0.6V<sub>DDQ</sub> and LOW below 0.4V<sub>DDQ</sub>.
2. Transition is measured ±200mV from steady-state.
3. These parameters are guaranteed with the AC load (Figure 1) by device characterization. They are not production tested.
4. To avoid bus contention, the output buffers are designed such that t<sub>CHZ</sub> (device turn-off) is about 1ns faster than t<sub>CLZ</sub> (device turn-on) at a given temperature and voltage. The specs as shown do not imply bus contention because t<sub>CLZ</sub> is a Min. parameter that is worse case at totally different test conditions (0 deg. C, 3.465V) than t<sub>CHZ</sub>, which is a Max. parameter (worse case at 70 deg. C, 3.135V).

## Timing Waveform of Read Cycle<sup>(1,2,3,4)</sup>

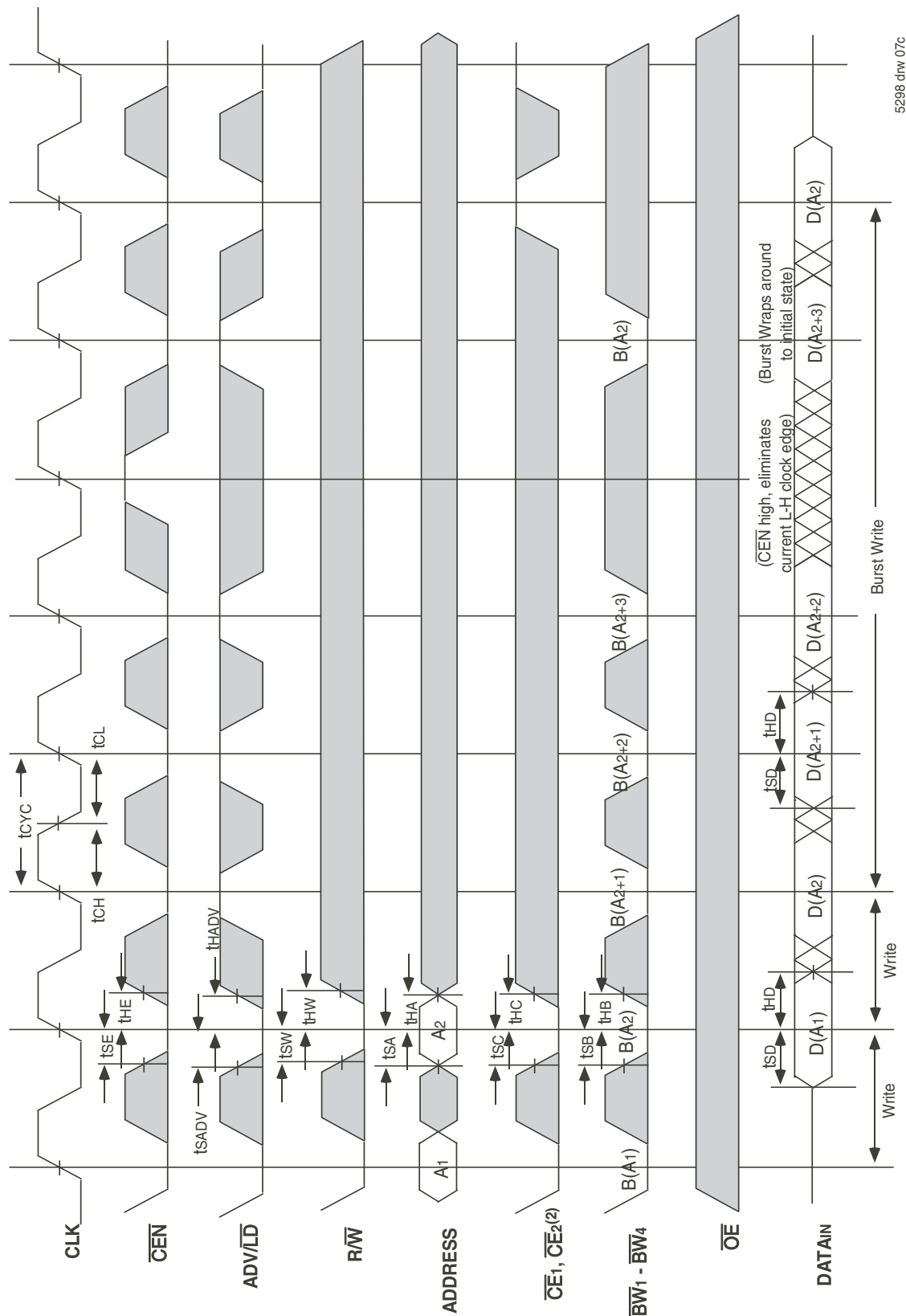


5298 drw 06

### NOTES:

1.  $Q(A_1)$  represents the first output from the external address  $A_1$ .  $Q(A_2)$  represents the first output from the external address  $A_2$ ;  $Q(A_2+1)$  represents the next output data in the burst sequence of the base address  $A_2$ , etc. where address bits  $A_0$  and  $A_1$  are advancing for the four word burst in the sequence defined by the state of the  $\overline{LBO}$  input.
2.  $CE_2$  timing transitions are identical but inverted to the  $\overline{CE_1}$  and  $\overline{CE_2}$  signals. For example, when  $\overline{CE_1}$  and  $\overline{CE_2}$  are LOW on this waveform,  $CE_1$  and  $CE_2$  are HIGH.
3. Burst ends when new address and control are loaded into the SRAM by sampling  $ADV/LD$  LOW.
4.  $R/W$  is don't care when the SRAM is bursting ( $ADV/LD$  sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the  $R/W$  signal when new address and control are loaded into the SRAM.

## Timing Waveform of Write Cycles(1,2,3,4,5)

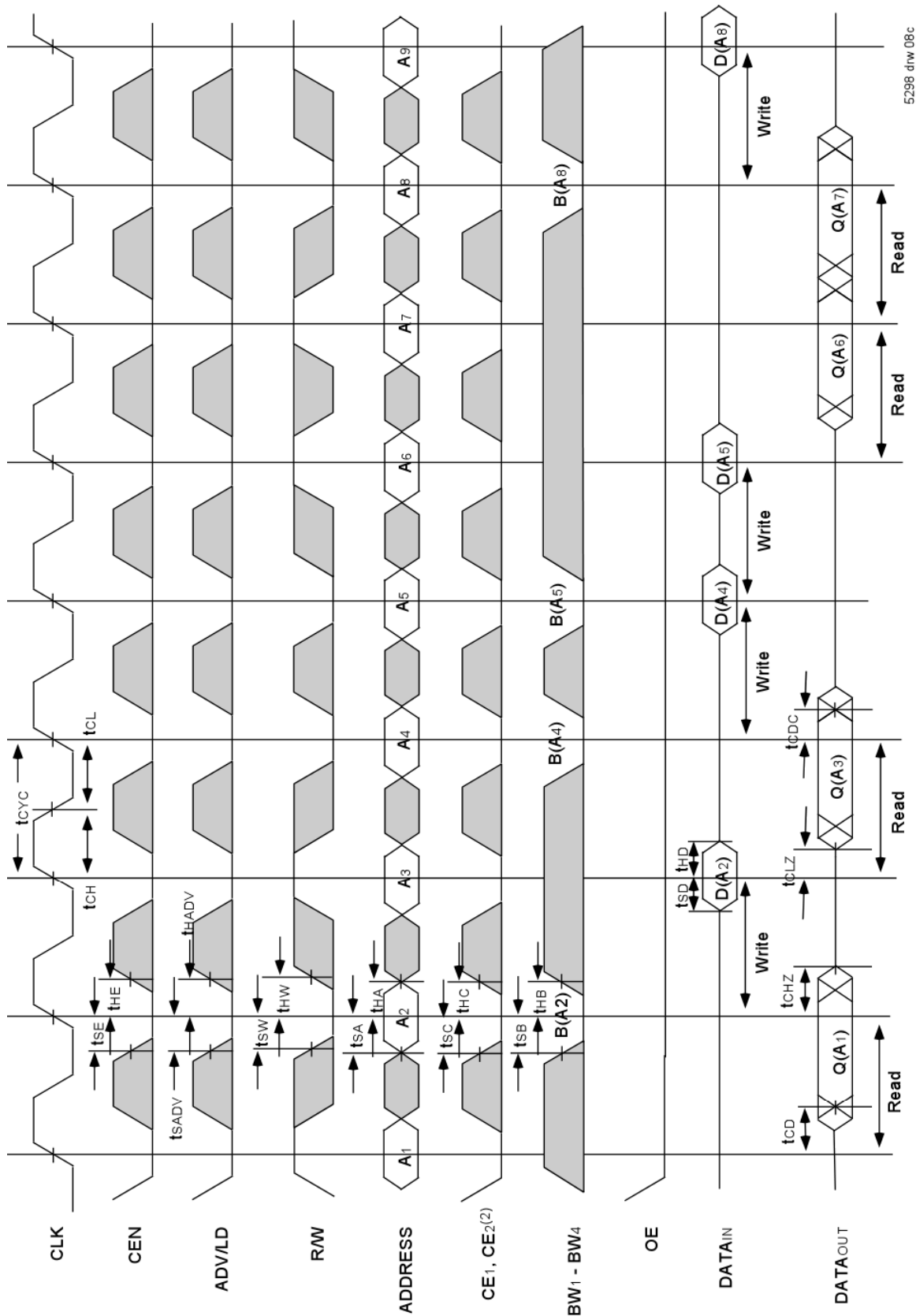


5298 dhw 07c

### NOTES:

1. D(A1) represents the first input to the external address A1. D(A2) represents the first input to the external address A2. D(A2+1) represents the next input data in the burst sequence of the base address A2, etc. where address bits A0 and A1 are advancing for the four word burst in the sequence defined by the state of the LBO input.
2. CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.
3. Burst ends when new address and control are loaded into the SRAM by sampling ADV/LD LOW.
4. R/W is don't care when the SRAM is bursting (ADV/LD sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the R/W signal when new address and control are loaded into the SRAM.
5. Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when R/W signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

## Timing Waveform of Combined Read and Write Cycles<sup>(1,2,3)</sup>

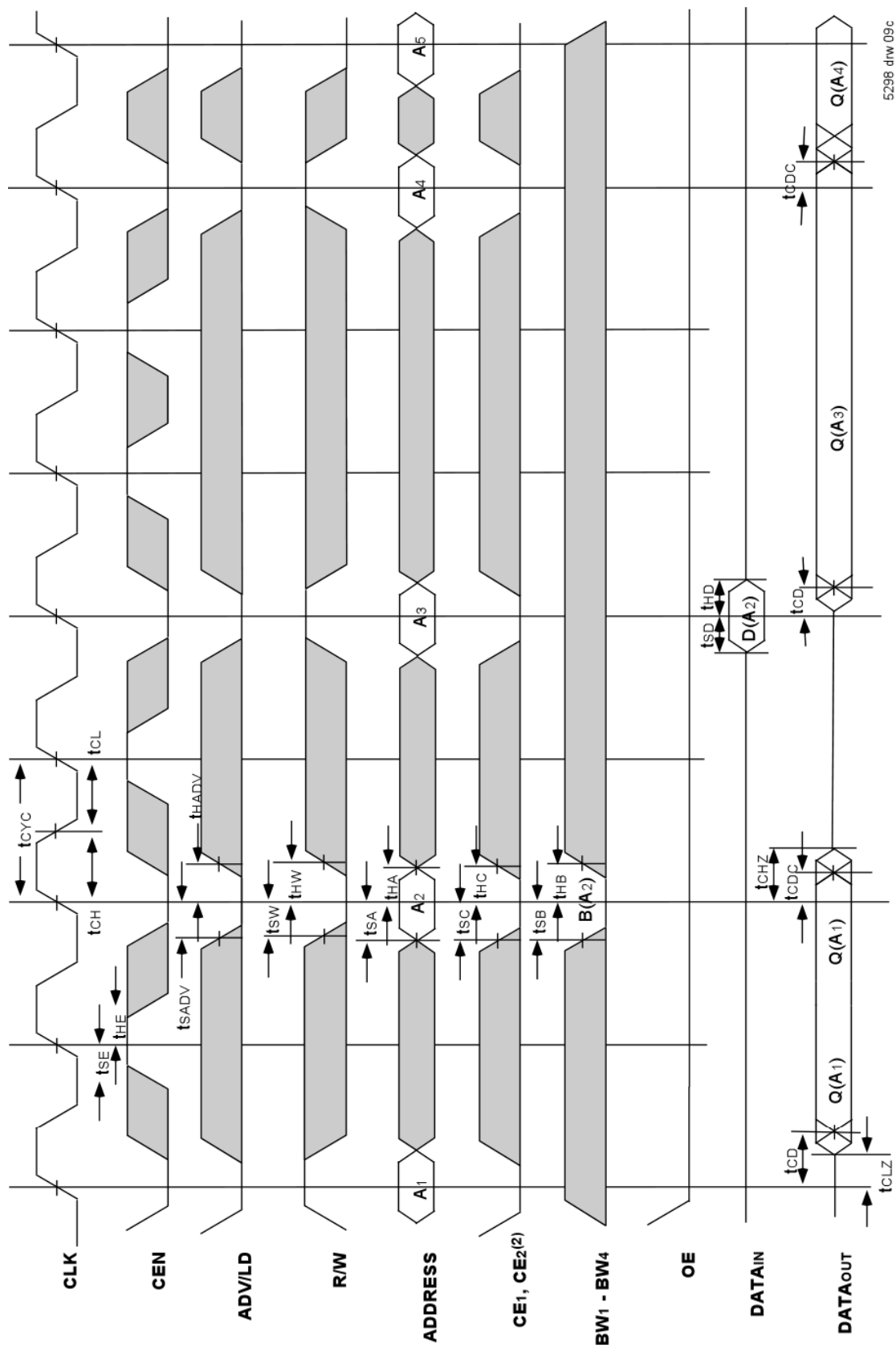


5298 drw 08c

### NOTES:

1. Q(A<sub>1</sub>) represents the first output from the external address A<sub>1</sub>. D(A<sub>2</sub>) represents the input data to the SRAM corresponding to address A<sub>2</sub>.
2. CE<sub>2</sub> timing transitions are identical but inverted to the  $\overline{CE1}$  and  $\overline{CE2}$  signals. For example, when  $\overline{CE1}$  and  $\overline{CE2}$  are LOW on this waveform, CE<sub>2</sub> is HIGH.
3. Individual Byte Write signals (BW<sub>x</sub>) must be valid on all write and burst-write cycles. A write cycle is initiated when RW signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

## Timing Waveform of $\overline{\text{CEN}}$ Operation<sup>(1,2,3,4)</sup>

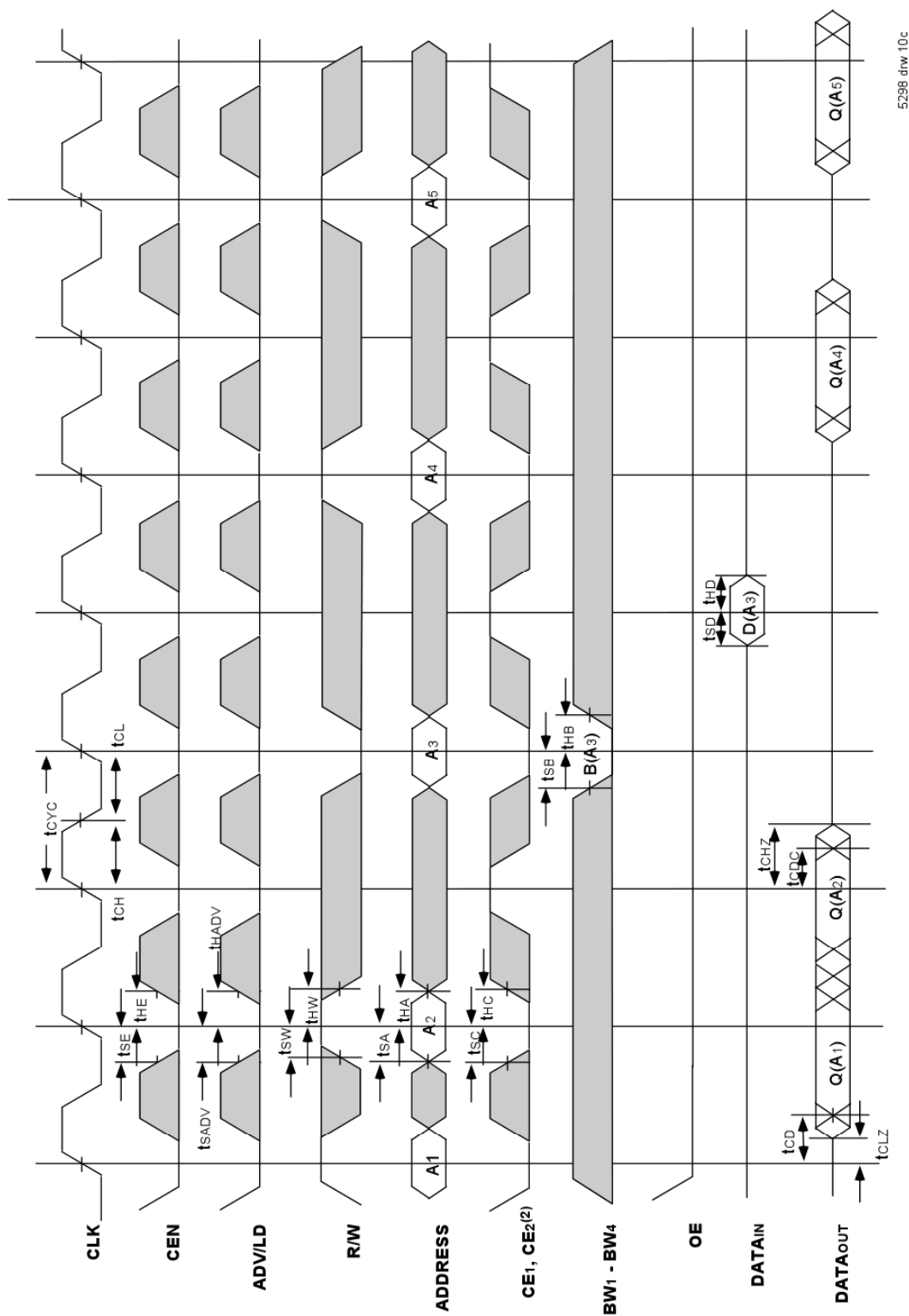


5298 drw 09c

### NOTES:

1. Q (A1) represents the first output from the external address A1. D (A2) represents the input data to the SRAM corresponding to address A2.
2. CE2 timing transitions are identical but inverted to the  $\overline{\text{CE1}}$  and  $\overline{\text{CE2}}$  signals. For example, when  $\overline{\text{CE1}}$  and  $\overline{\text{CE2}}$  are LOW on this waveform, CE2 is HIGH.
3.  $\overline{\text{CEN}}$  when sampled high on the rising edge of clock will block that L-H transition of the clock from propagating into the SRAM. The part will behave as if the L-H clock transition did not occur. All internal registers in the SRAM will retain their previous state.
4. Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when  $\overline{\text{R/W}}$  signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

## Timing Waveform of $\overline{\text{CS}}$ Operation<sup>(1,2,3,4)</sup>

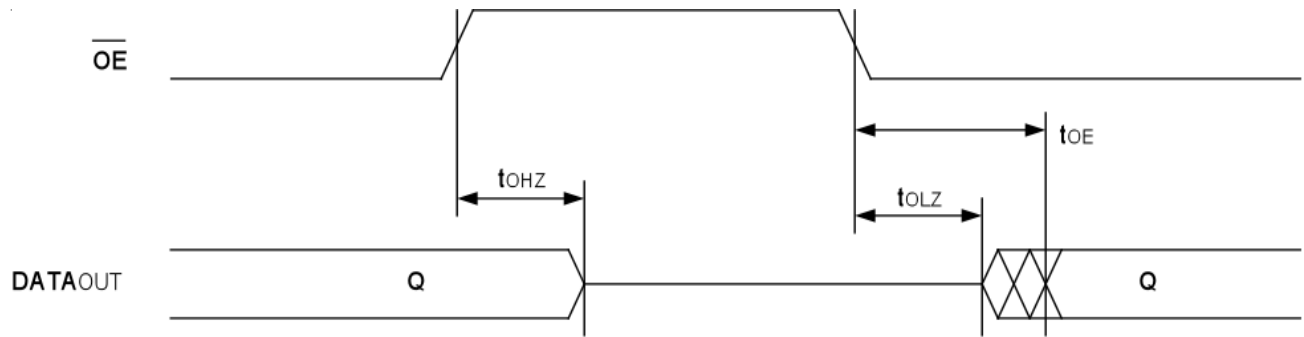


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### NOTES:

1. Q(A<sub>1</sub>) represents the first output from the external address A<sub>1</sub>. D(A<sub>3</sub>) represents the input data to the SRAM corresponding to address A<sub>3</sub> etc.
2. CE<sub>2</sub> timing transitions are identical but inverted to the  $\overline{\text{CE1}}$  and  $\overline{\text{CE2}}$  signals. For example, when  $\overline{\text{CE1}}$  and  $\overline{\text{CE2}}$  are LOW on this waveform,  $\overline{\text{CE2}}$  is HIGH.
3. When either one of the Chip enables ( $\overline{\text{CE1}}$ ,  $\overline{\text{CE2}}$ ,  $\overline{\text{CE2}}$ ) is sampled inactive at the rising clock edge, a deselect cycle is initiated. The data-bus tri-states one cycle after the initiation of the deselect cycle. This allows for any pending data transfers (reads or writes) to be completed.
4. Individual Byte Write signals (BW<sub>x</sub>) must be valid on all write and burst-write cycles. A write cycle is initiated when  $\overline{\text{R/W}}$  signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

## Timing Waveform of $\overline{OE}$ Operation<sup>(1)</sup>



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**NOTE:**

1. A read operation is assumed to be in progress.

## Ordering Information

| XXXX        | S     | XX    | X       | X | X                             | X                             |  |                                                                                                                 |
|-------------|-------|-------|---------|---|-------------------------------|-------------------------------|--|-----------------------------------------------------------------------------------------------------------------|
| Device Type | Power | Speed | Package |   | Process/<br>Temperature Range |                               |  |                                                                                                                 |
|             |       |       |         |   |                               | Blank 8                       |  | Tube or Tray<br>Tape and Reel                                                                                   |
|             |       |       |         |   |                               | Blank I                       |  | Commercial (0°C to +70°C)<br>Industrial (-40°C to +85°C)                                                        |
|             |       |       |         |   |                               | G                             |  | Green                                                                                                           |
|             |       |       |         |   |                               | PF<br>BG<br>BQ                |  | 100-pin Plastic Thin Quad Flatpack (TQFP)<br>119 Ball Grid Array (BGA)<br>165 Fine Pitch Ball Grid Array (fBGA) |
|             |       |       |         |   |                               | 75 <sup>(1)</sup><br>80<br>85 |  | Access time (tCD) in tenths of nanoseconds                                                                      |
|             |       |       |         |   |                               | IDT71V65703<br>IDT71V65903    |  | 256Kx36 Flow-Through ZBT SRAM<br>512Kx18 Flow-Through ZBT SRAM                                                  |

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**NOTE:**

1. 71V65703 only.

## Datasheet Document History

|          |                  |                                                                                                                               |
|----------|------------------|-------------------------------------------------------------------------------------------------------------------------------|
| 12/31/99 |                  | Created new part number and datasheet from 71V657/59 to 71v65703/5903                                                         |
| 04/20/00 | Pg.5,6           | Add JTAG reset pins to TQFP pin configuration; removed footnote                                                               |
|          |                  | Add clarification note to Recommended Operating Temperature and Absolute Max Ratings tables                                   |
|          | Pg. 7            | Add note to BGA pin configuration; corrected typo within pinout                                                               |
|          | Pg. 21           | Insert TQFP Package Diagram Outline                                                                                           |
| 05/23/00 |                  | Add new package offering: 13mm x 15mm, 165 fine pitch ball grid array                                                         |
|          | Pg. 23           | Correction on 119 Ball Grid Array Package diagram Outline                                                                     |
| 07/28/00 | Pg. 5-8          | Remove JTAG pins from TQFP, BG119 and BQ165 pinouts, refer to IDT71V656xx and IDT71V658xx device errata sheet                 |
|          | Pg. 7,8          | Correct error in pinout, B2 on BG119 and B1 on BQ165 pinout                                                                   |
|          | Pg. 23           | Update BG119 package diagram dimensions                                                                                       |
| 11/04/00 | Pg. 8            | Add reference note to pin N5 on the BQ165 pinout, reserved for JTAG $\overline{\text{TRST}}$                                  |
|          | Pg. 15           | Add I <sub>ZZ</sub> to DC Electrical Characteristics                                                                          |
| 12/04/02 | Pg. 1-25         | Changed datasheet from Preliminary to final release                                                                           |
|          | Pg. 5,6,15,16,25 | Added I temp to datasheet                                                                                                     |
| 12/18/02 | Pg. 1,2,5,6,7,8  | Removed JTAG functionality for current die revision                                                                           |
|          | Pg. 7            | Corrected pin configuration on the x36, 119 BGA. Switched pins I/O0 and I/OP1.                                                |
| 10/16/14 | Pg. 1            | Added green availability to Features and corrected a typo                                                                     |
|          | Pg. 15           | DC Electrical Chars Table corrected typos for I <sub>DD</sub> in the Industrial Temp range for the 8.0ns & 8.5ns speed grades |
|          | Pg. 22           | Removed IDT from and added green and T&R indicators to the ordering information                                               |
|          |                  | Added <sup>(1)</sup> footnote annotation to 75 access speed in the ordering information table                                 |
|          |                  | Added the corresponding footnote to the text "71V65703 only".                                                                 |



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